32E. Flexible Electronic Device Fabrication and Process

**Session Date:** March 9(Thu.), 2023  
**Session Time:** 13:00-14:30  
**Session Room:** Room E (#308 a)  
**Session Chair:** Prof. Keehoon Kang (Seoul National University)

- **[32E-1] [Keynote]**  
  13:00-13:25  
  *Ultra-Thin Atomic-Layer-Deposited InGaZnO Thin Film Transistors with Back-End-of Line Compatibility*  
  Jie Zhang, Zhuocheng Zhang, Zehao Lin, Dongqi Zheng, and Peide D. Ye  
  Purdue University

- **[32E-2] [Invited]**  
  13:25-13:50  
  *Flexible Electronics with Two-Dimensional and Layered Chalcogenide Compounds*  
  Alwin Daus  
  RWTH Aachen University

- **[32E-3] [Invited]**  
  13:50-14:15  
  *Additive Manufacturing for Flexible Micro-and Nanoelectronics*  
  Ji Tae Kim  
  The University of Hong Kong

- **[32E-4]**  
  14:15-14:30  
  *Continuous Liquid Metal Printing for Rapid Metal Oxide TFT Integration*  
  William J. Scheideler, Andrew B. Hamlin, Youxiong Ye and Simon Agnew  
  Dartmouth College